

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L4	1	("4684560").PN	US-PGPUB; USPAT; USOCR	OR	OFF	2006/01/20 10:33
L5	11947	(carbon) with (particle) with (size or diameter) with (micron or micro\$1meter or "mu.m")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 13:48
L6	295	5 and (electro\$1plating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 12:57
L7	4246	5 and (board or substrate or non\$conductive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 10:36
L8	242	6 and 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 10:57
L9	2296	5 and ((water) with (dispersible or soluble))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 13:32
L10	398	5 and (binding adj agent)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 11:00
L11	143	9 and 10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 11:04

L12	2463	5 and ((coat or coating) with (thick or thickness))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 12:58
L13	141	6 and 12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 12:58
L14	268	9 and (monosaccharide\$1 or polysaccharide\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 13:45
L15	38	6 and 14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 13:43
L16	230	14 not 15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 13:43
L17	43	9 and ((binding or binder) with (monosaccharide\$1 or polysaccharide\$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 13:48
L18	1528	(carbon) with (graphite) with (size or diameter) with (micron or micro\$1meter or "mu.m")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 13:49
L19	448	7 and 18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 13:49

S9	184	S1 or S2 or S3 or S4 or S5 or S6 or S7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 14:34
S10	184	S1 or S2 or S3 or S4 or S5 or S6 or S7	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/19 14:34
S11	132	((board or substrate or non\$1conductive) with (carbon or graphite) with (size) with (particle)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 14:38
S12	229	((board or substrate or non\$1conductive) with (carbon or graphite) with (size) with (particle)).ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 14:36
S13	345	S11 or S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 14:36
S14	646	((board or substrate or non\$1conductive) with (carbon or graphite) with (size) with (particle))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 15:42
S15	5	S13 and (water with dispersible with organic with binding with agent)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 14:42
S16	5	S13 and (water with dispersible with organic with binding with agent)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 14:40
S17	5	S14 and (water with dispersible with organic with binding with agent)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 14:41

S18	0	S16 not S15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 14:43
S19	0	S17 not S15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 14:43
S20	34	S14 and (binding adj agent)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 15:45
S21	17	S20 and ((water) with (binding adj agent))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 15:43
S22	17	S20 not S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 15:48
S23	7524	((174/257) or (174/255) or (174/262) or (174/265) or (174/256) or (174/266) or (174/268) or (205/159) or (205/162) or (205/164) or (205/210) or (427/97.2) or (427/97.8) or (427/97.9) or (427/98.2) or (427/98.3)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/19 15:53
S24	1310	S23 and (carbon or graphite)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/19 15:54
S25	897	S24 and ((board or substrate or non\$1conductive) and (via or hole or slot or opening))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/20 09:05

S26	1	("6927347").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/01/19 17:29
S27	1	("20040201096").PN.	US-PGPUB	OR	OFF	2006/01/19 17:31
S28	1	("4783722").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/01/19 17:46
S29	1	("5523920").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/01/19 18:15